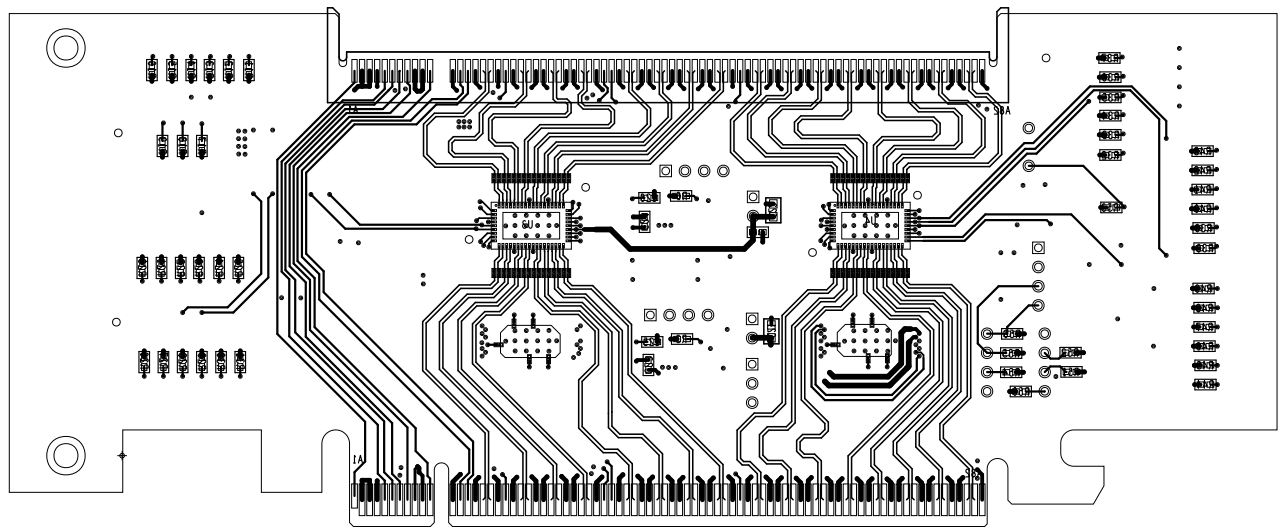
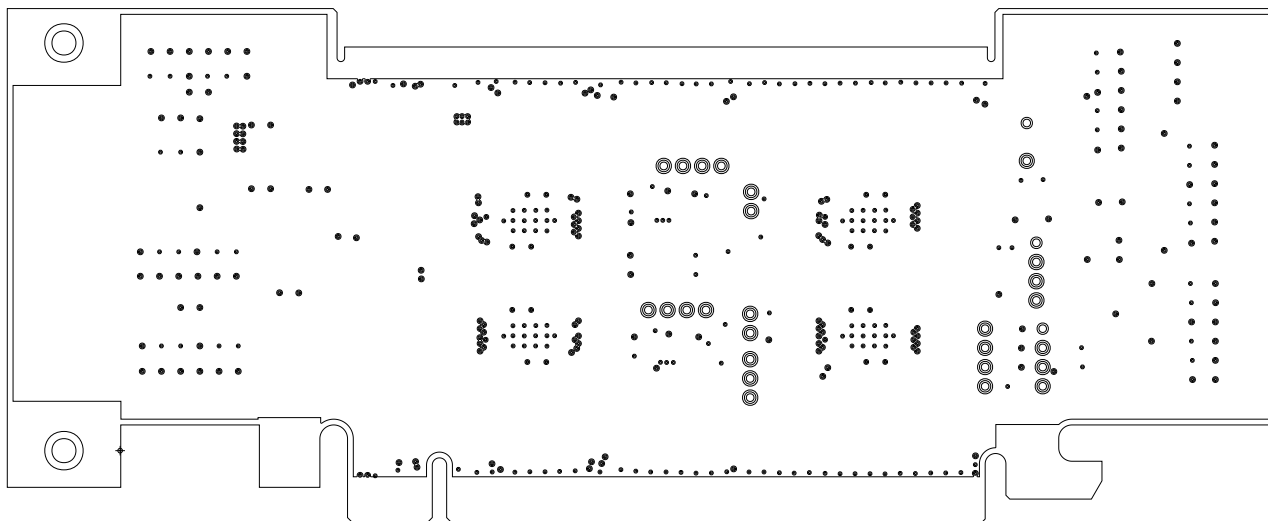


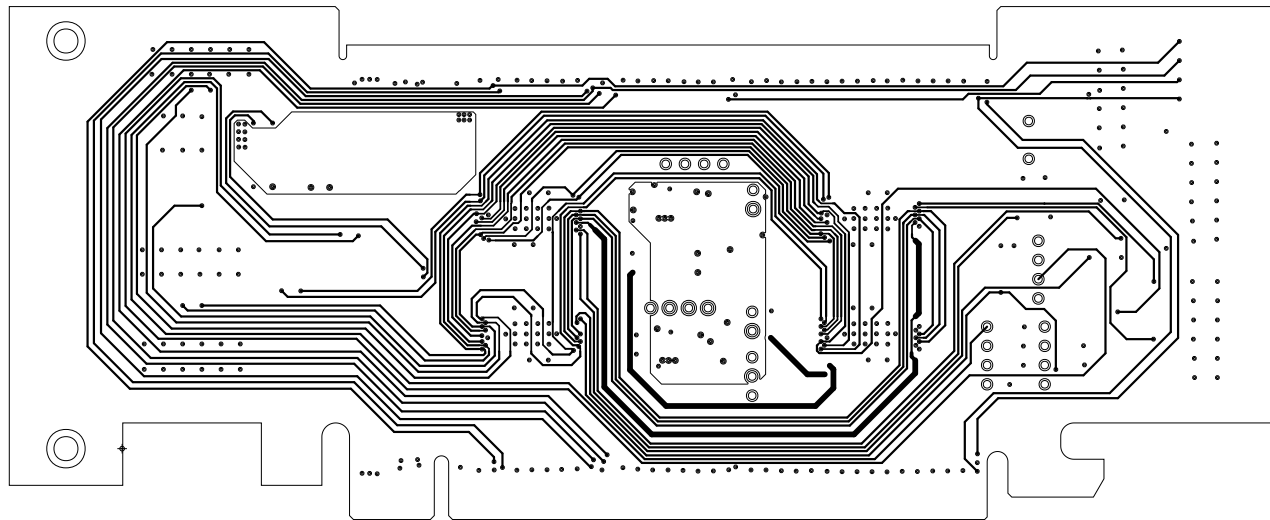
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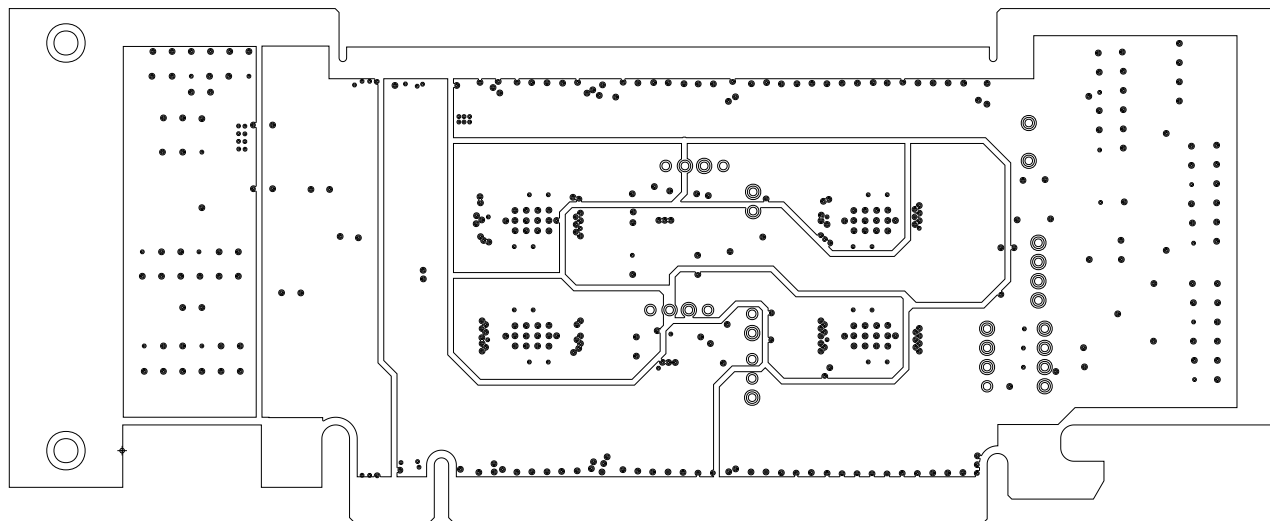
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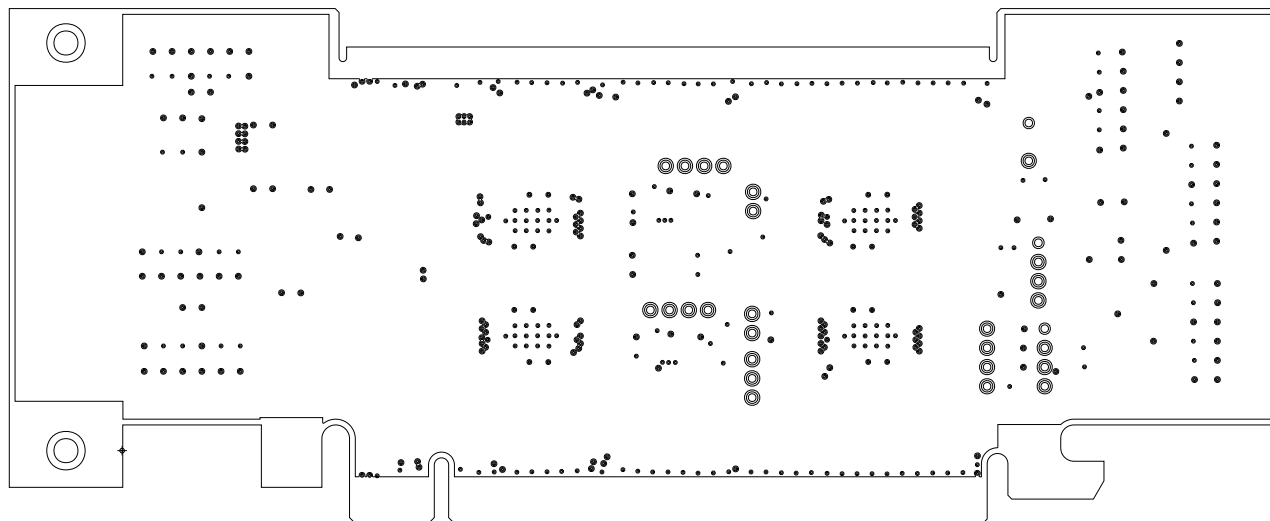
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REV: 1

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TEXAS INSTRUMENTS		
TIDA00423_DS80PCI810_REFERENCE_DESIGN		
DATE: JAN 2015	JOB: 305-PD-13-0341	REV: 1
LAYER: GND2		

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